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103123521

To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Hideki KEMMOCHI (10/27/2005) and Jordi BONADA (11/02/2005)

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Yamaha Corporation

Internal Address: _____

Street Address: _____

10-1, Nakazawa-cho
Hamamatsu-Shi
430-8650
JAPAN

City: _____

State: _____

Country: _____ Zip: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

☒ Assignment ☐ Merger ☐ Change of Name

☐ Security Agreement ☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other _____

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: David L. Fehrman
MORRISON & FOERSTER LLP

Internal Address: Atty. Dkt.: 393032056600

Street Address: 555 West Fifth Street

City: Los Angeles

State: CA Zip: 90013-1024

Phone Number: (213) 892-5601

Fax Number: (213) 892-5454

Email Address: DFehrman@mofo.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☐ Authorized to be charged by credit card

☒ Authorized to be charged to deposit account

☐ Enclosed

☐ None required (government interest not affecting title)


8. Payment Information

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Authorized User Name David L. Fehrman

9. Signature:



Signature

David T. Yang - 44,415

Name of Person Signing

November 14, 2005

Date

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MORRISON & FOERSTER LLP
United States Patent Rights

Attorney Docket No. 39303-20566.00

ASSIGNMENT

WHEREAS, Hideki KEMMOCHI and Jordi BONADA
(hereinafter designated as the undersigned) has (have) invented certain new and useful
improvements in APPARATUS FOR AND PROGRAM OF PROCESSING AUDIO
SIGNAL

for which an application for Letters Patent of the United States of America has been
executed by the undersigned on even date herewith, and;

WHEREAS, YAMAHA CORPORATION of 10-1, Nakazawa-cho, Hamamatsu-shi,
Shizuoka-ken, 430-8650 Japan its heirs,
successors, legal representatives and assigns (hereinafter designated as the Assignee) is
desirous of acquiring the entire right, title and interest in and to said invention and in and to
any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the
undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and
valuable consideration, the undersigned has (have) sold, assigned and transferred, and by
these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the
said invention in the United States of America and its territories and for all foreign countries,
dependencies and possessions and the entire right, title and interest in and to any and all
Letters Patent(s) which may be granted therefor in the United States of America and its
territories, dependencies and possessions, and in and to any and all divisions, reissues,
continuations and extensions thereof for the full term or terms for which the same may be
granted.

The undersigned agree(s) to execute all papers necessary in connection with this
application and any continuing, divisional or reissue applications thereof and also to execute
separate assignments in connection with such applications as the Assignee may deem
necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any
interference which may be declared concerning this application or any continuation, division
or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with
the Assignee in every way possible in obtaining and producing evidence and proceeding with
such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act
which may be necessary in connection with claims under or provisions of the International
Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of MORRISON & FOERSTER LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

This Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Oct. 27, 2005 Name of Inventor Hideki Kemmochi (SEAL)
Hideki KEMMOCHI

Date Nov. 2, 2005 Name of Inventor Jordi Bonada (SEAL)
Jordi BONADA